

TPS3306-15-Q1, TPS3306-18-Q1, TPS3306-20-Q1, TPS3306-25-Q1, TPS3306-33-Q1 DUAL PROCESSOR SUPERVISORY CIRCUITS WITH POWER FAIL

SGLS241B – MARCH 2004 – REVISED APRIL 2008

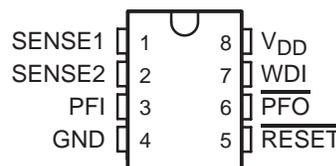
- Qualified for Automotive Applications
- Dual Supervisory Circuits With Power Fail for DSP and Processor-Based Systems
- Voltage Monitor for Power Fail or Low-Battery Warning
- Watchdog Timer With 0.8-s Time-Out
- Power-On Reset Generator With Integrated 100-ms Delay Time
- Open-Drain Reset and Power-Fail Output
- Supply Current of 15 μ A (Typ)
- Supply Voltage Range . . . 2.7 V to 6 V
- Defined $\overline{\text{RESET}}$ Output From $V_{\text{DD}} \geq 1.1$ V
- SO-8 Package
- Temperature Range . . . -40°C to 125°C
- Applications Include:
Multivoltage DSPs and Processors
Portable Battery-Powered Equipment
Embedded Control Systems
Intelligent Instruments
Automotive Systems

description

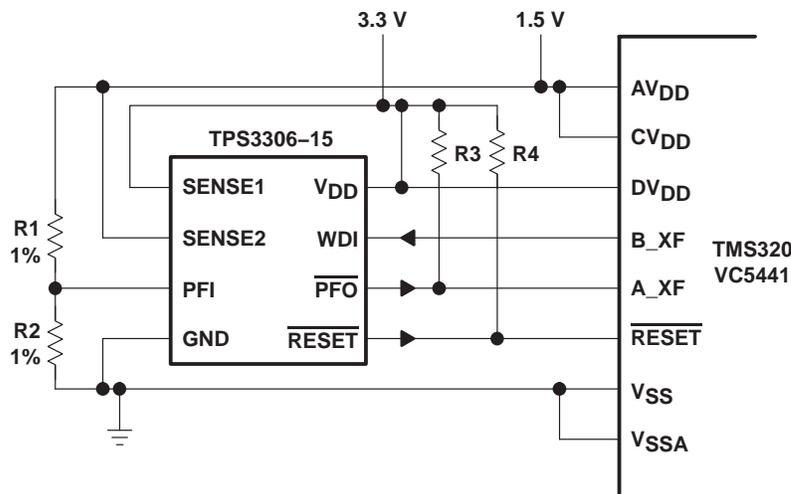
The TPS3306 family is a series of supervisory circuits designed for circuit initialization, which require two supply voltages, primarily in DSP and processor-based systems.

The product spectrum of the TPS3306-xx is designed for monitoring two independent supply voltages of 3.3 V/1.5 V, 3.3 V/1.8 V, 3.3 V/2 V, 3.3 V/2.5 V, or 3.3 V/5 V.

D PACKAGE
(TOP VIEW)



TYPICAL OPERATING CIRCUIT



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

 **TEXAS
INSTRUMENTS**

POST OFFICE BOX 655303 • DALLAS, TEXAS 75265

Copyright © 2008 Texas Instruments Incorporated

TPS3306-15-Q1, TPS3306-18-Q1, TPS3306-20-Q1, TPS3306-25-Q1, TPS3306-33-Q1 DUAL PROCESSOR SUPERVISORY CIRCUITS WITH POWER FAIL

SGLS241B – MARCH 2004 – REVISED APRIL 2008

description (continued)

The various supervisory circuits are designed to monitor the nominal supply voltage, as shown in the following supply-voltage monitoring table.

SUPPLY-VOLTAGE MONITORING

DEVICE	NOMINAL SUPERVISED VOLTAGE		THRESHOLD VOLTAGE (TYP)	
	SENSE1	SENSE2	SENSE1	SENSE2
TPS3306-15	3.3 V	1.5 V	2.93 V	1.4 V
TPS3306-18	3.3 V	1.8 V	2.93 V	1.68 V
TPS3306-20	3.3 V	2 V	2.93 V	1.85 V
TPS3306-25	3.3 V	2.5 V	2.93 V	2.25 V
TPS3306-33	5 V	3.3 V	4.55 V	2.93 V

During power on, $\overline{\text{RESET}}$ is asserted when the supply voltage, V_{DD} , becomes higher than 1.1 V. Thereafter, the supervisory circuits monitor the SENSEn inputs and keep $\overline{\text{RESET}}$ active as long as SENSEn remains below the threshold voltage, V_{IT} .

An internal timer delays the return of the $\overline{\text{RESET}}$ output to the inactive state (high) to ensure proper system reset. The delay time, $t_{d(\text{typ})} = 100 \text{ ms}$, starts after SENSE1 and SENSE2 inputs have risen above V_{IT} . When the voltage at SENSE1 or SENSE2 input drops below the V_{IT} , the output becomes active (low) again.

The integrated power-fail (PFI) comparator with separate open-drain ($\overline{\text{PFO}}$) output can be used for low-battery detection, power-fail warning, or for monitoring a power supply other than the main supply.

The TPS3306-xx devices integrate a watchdog timer that is periodically triggered by a positive or negative transition of the watch-dog timer (WDI). When the supervising system fails to retrigger the watchdog circuit within the time-out interval, $t_{t(\text{out})} = 0.50 \text{ s}$, $\overline{\text{RESET}}$ becomes active for the time period t_d . This event also reinitializes the watchdog timer. Leaving WDI unconnected disables the watchdog.

The TPS3306-xx devices are available in standard 8-pin SO packages.

The TPS3306-xxQ family is characterized for operation over a temperature range of -40°C to 125°C .

AVAILABLE OPTIONS†

T _A	PACKAGED DEVICES‡		TOP-SIDE MARKING
	SMALL OUTLINE (D)		
-40°C to 125°C	Tape and reel	TPS3306-15QDRQ1	615Q1
	Tape and reel	TPS3306-18QDRQ1	618Q1
	Tape and reel	TPS3306-20QDRQ1	620Q1
	Tape and reel	TPS3306-25QDRQ1	625Q1
	Tape and reel	TPS3306-33QDRQ1	633Q1

† For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI web site at <http://www.ti.com>.

‡ Package drawings, thermal data, and symbolization are available at <http://www.ti.com/packaging>.

TPS3306-15-Q1, TPS3306-18-Q1, TPS3306-20-Q1, TPS3306-25-Q1, TPS3306-33-Q1 DUAL PROCESSOR SUPERVISORY CIRCUITS WITH POWER FAIL

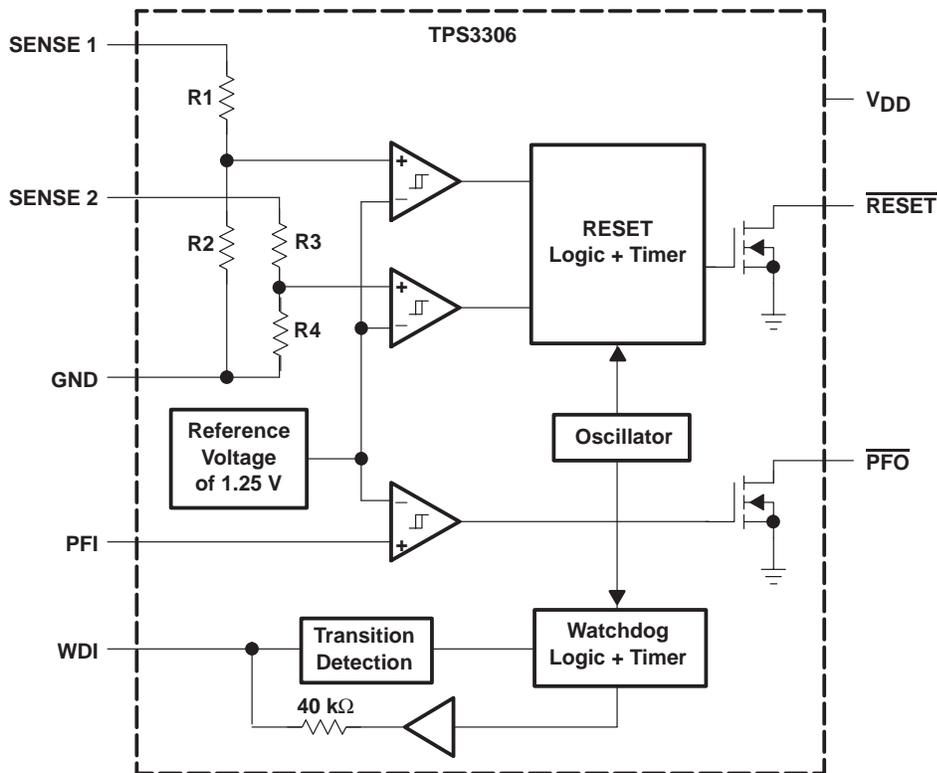
SGLS241B – MARCH 2004 – REVISED APRIL 2008

FUNCTION/TRUTH TABLES

SENSE1 > V _{IT1}	SENSE2 > V _{IT2}	$\overline{\text{RESET}}$
0	0	L
0	1	L
1	0	L
1	1	H

PFI > V _{IT}	$\overline{\text{PFO}}$	TYPICAL DELAY
0→1	L→H	0.5 μs
1→0	H→L	0.5 μs

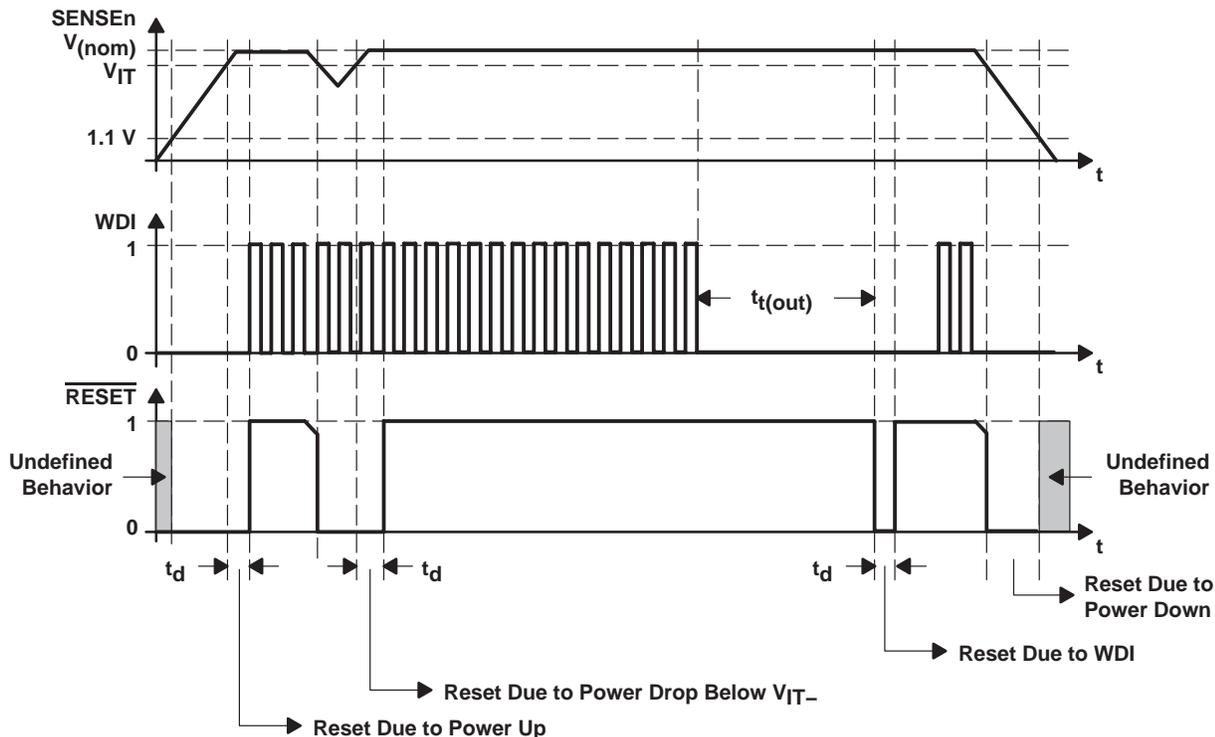
functional block diagram



TPS3306-15-Q1, TPS3306-18-Q1, TPS3306-20-Q1, TPS3306-25-Q1, TPS3306-33-Q1 DUAL PROCESSOR SUPERVISORY CIRCUITS WITH POWER FAIL

SGLS241B – MARCH 2004 – REVISED APRIL 2008

timing diagram



Terminal Functions

TERMINAL NAME	NO.	I/O	DESCRIPTION
GND	4	I	Ground
PFI	3	I	Power-fail comparator input
PFO	6	O	Power-fail comparator output, open drain
RESET	5	O	Active-low reset output, open drain
SENSE1	1	I	Sense voltage 1
SENSE2	2	I	Sense voltage 2
WDI	7	I	Watchdog timer input
VDD	8	I	Supply voltage

detailed description

watchdog

In a microprocessor- or DSP-based system, it is not only important to supervise the supply voltage, it is also important to ensure correct program execution. The task of a watchdog is to ensure that the program is not stalled in an indefinite loop. The microprocessor, microcontroller, or DSP has to typically toggle the watchdog input (WDI) within 0.8 s to avoid a time-out occurring. Either a low-to-high or a high-to-low transition resets the internal watchdog timer. If the input is unconnected or tied with a high-impedance driver, the watchdog is disabled and is retriggered internally.



saving current while using the watchdog

WDI is internally driven low during the first 7/8 of the watchdog time-out period, then momentarily pulses high, resetting the watchdog counter. For minimum watchdog input current (minimum overall power consumption), leave WDI low for the majority of the watchdog time-out period, pulsing it low-high-low once within 7/8 of the watchdog time-out period to reset the watchdog timer. If, instead, WDI is externally driven high for the majority of the time-out period, a current of $5\text{ V}/40\text{ k}\Omega \approx 125\text{ }\mu\text{A}$ can flow into WDI.

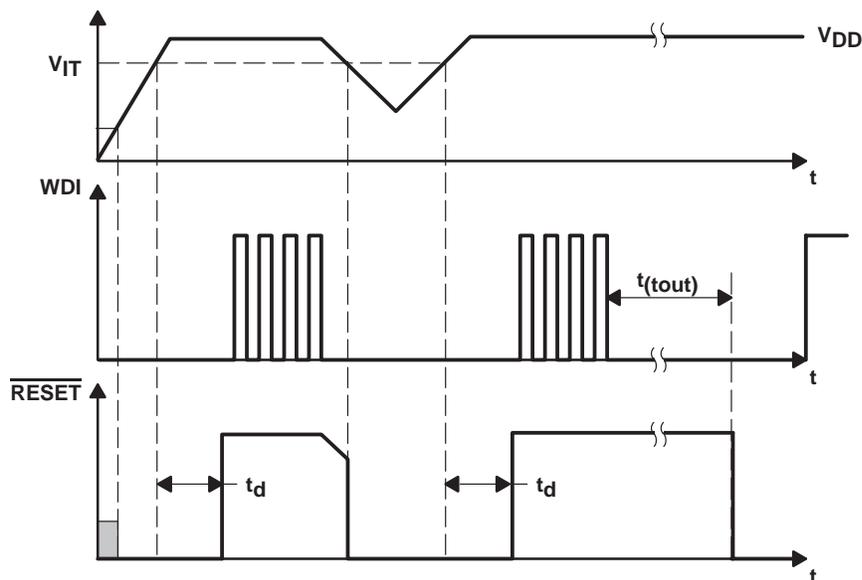
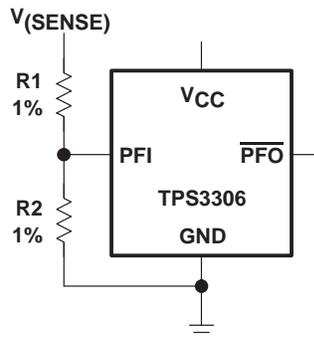


Figure 1. Watchdog Timing

power-fail comparator (PFI and PFO)

An additional comparator is provided to monitor voltages other than the nominal supply voltage. The power-fail-input (PFI) is compared with an internal voltage reference of 1.25 V. If the input voltage falls below the power-fail threshold (V_{PFI}) of 1.25 V (typ), the power-fail output (\overline{PFO}) goes low. If \overline{PFO} goes above 1.25 V plus about 10-mV hysteresis, the output returns to high. By connecting two external resistors, it is possible to supervise any voltages above 1.25 V. The sum of both resistors should be approximately 1 M Ω , to minimize power consumption and also to ensure that the current in the PFI pin can be neglected compared with the current through the resistor network. The tolerance of the external resistors should be not more than 1% to ensure minimal variation of sensed voltage. If the power-fail comparator is unused, connect PFI to ground and leave \overline{PFO} unconnected.

$$V_{PFI,trip} = 1.25\text{ V} \times \frac{R_1 + R_2}{R_2}$$



TPS3306-15-Q1, TPS3306-18-Q1, TPS3306-20-Q1, TPS3306-25-Q1, TPS3306-33-Q1 DUAL PROCESSOR SUPERVISORY CIRCUITS WITH POWER FAIL

SGLS241B – MARCH 2004 – REVISED APRIL 2008

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage (see Note1): V_{DD}	7 V
All other pins	-0.3 V to 7 V
Maximum low output current, I_{OL}	5 mA
Maximum high output current, I_{OH}	-5 mA
Input clamp current, I_{IK} ($V_I < 0$ or $V_I > V_{DD}$)	± 20 mA
Output clamp current, I_{OK} ($V_O < 0$ or $V_O > V_{DD}$)	± 20 mA
Continuous total power dissipation	See Dissipation Rating Table
Operating free-air temperature range, T_A	-40°C to 125°C
Storage temperature range, T_{stg}	-65°C to 150°C
Soldering temperature	260°C

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: All voltage values are with respect to GND. For reliable operation, the device must not be operated at 7 V for more than $t = 1000$ h continuously.

DISSIPATION RATING TABLE

PACKAGE	$T_A \leq 25^\circ\text{C}$ POWER RATING	DERATING FACTOR ABOVE $T_A = 25^\circ\text{C}$	$T_A = 70^\circ\text{C}$ POWER RATING	$T_A = 85^\circ\text{C}$ POWER RATING
D	725 mW	5.8 mW/°C	464 mW	377 mW

recommended operating conditions at specified temperature range

	MIN	MAX	UNIT
Supply voltage, V_{DD}	2.7	6	V
Input voltage at WDI and PFI, V_I	0	$V_{DD} + 0.3$	V
Input voltage at SENSE1 and SENSE2, V_I	0	$(V_{DD} + 0.3)V_{IT}/1.25$ V	V
High-level input voltage at WDI, V_{IH}	$0.7 \times V_{DD}$		V
Low-level input voltage at WDI, V_{IL}		$0.3 \times V_{DD}$	V
Operating free-air temperature range, T_A	-40	125	°C



TPS3306-15-Q1, TPS3306-18-Q1, TPS3306-20-Q1, TPS3306-25-Q1, TPS3306-33-Q1 DUAL PROCESSOR SUPERVISORY CIRCUITS WITH POWER FAIL

SGLS241B – MARCH 2004 – REVISED APRIL 2008

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT	
V _{OL}	Low-level output voltage	V _{DD} = 2.7 V to 6 V, I _{OL} = 20 μA			0.2	V	
		V _{DD} = 3.3 V, I _{OL} = 2 mA			0.4		
		V _{DD} = 6 V, I _{OL} = 3 mA			0.4		
Power-up reset voltage (see Note 2)		V _{DD} ≥ 1.1 V, I _{OL} = 20 μA			0.4	V	
V _{IT}	Negative-going input threshold voltage (see Note 3)	V _{DD} = 2.7 V to 6 V, T _A = -40°C to 125°C		1.35	1.4	1.44	V
				1.62	1.68	1.74	
				1.79	1.85	1.91	
				2.18	2.25	2.34	
				2.84	2.93	3.04	
				4.44	4.55	4.68	
		PFI		1.2	1.25	1.3	
V _{hys}	Hysteresis	PFI	V _{IT} = 1.25 V		10	mV	
		VSENSE _n	V _{IT} = 1.4 V		15		
			V _{IT} = 1.68 V		15		
			V _{IT} = 1.86 V		20		
			V _{IT} = 2.25 V		20		
			V _{IT} = 2.93 V		30		
			V _{IT} = 4.55 V		40		
I _{H(AV)}	Average high-level input current	WDI	WDI = V _{DD} = 6 V, Time average (dc = 88%)		100	150	μA
I _{L(AV)}	Average low-level input current	WDI	WDI = 0 V, V _{DD} = 6 V, Time average (dc = 12%)		-15	-20	μA
I _H	High-level input current	WDI	WDI = V _{DD} = 6 V		120	170	μA
		SENSE1	V _{SENSE1} = V _{DD} = 6 V		5	10	
		SENSE2	V _{SENSE2} = V _{DD} = 6 V		6	10	
I _L	Low-level input current	WDI	WDI = 0 V, V _{DD} = 6 V		-120	-170	μA
I _I	Input current	PFI	V _{DD} = 6 V, 0 V ≤ V _I ≤ V _{DD}		-30	30	nA
I _{DD}	Supply current				15	40	μA
C _i	Input capacitance		V _I = 0 V to V _{DD}		10		pF

NOTES: 2. The lowest supply voltage at which RESET becomes active. t_r, V_{DD} ≥ 15 μs/V.
3. To ensure best stability of the threshold voltage, a bypass capacitor (ceramic 0.1 μF) should be placed close to the supply terminals.

timing requirements at V_{DD} = 2.7 V to 6 V, R_L = 1 MΩ, C_L = 50 pF, T_A = 25°C

PARAMETER		TEST CONDITIONS	MIN	MAX	UNIT
t _w	SENSE _n	V _{SENSEnL} = V _{IT} - 0.2 V, V _{SENSEnH} = V _{IT} + 0.2 V	6		μs
	WDI	V _{IH} = 0.7 × V _{DD} , V _{IL} = 0.3 × V _{DD}	100		ns



TPS3306-15-Q1, TPS3306-18-Q1, TPS3306-20-Q1, TPS3306-25-Q1, TPS3306-33-Q1 DUAL PROCESSOR SUPERVISORY CIRCUITS WITH POWER FAIL

SGLS241B – MARCH 2004 – REVISED APRIL 2008

switching characteristics at $V_{DD} = 2.7\text{ V to }6\text{ V}$, $R_L = 1\text{ M}\Omega$, $C_L = 50\text{ pF}$, $T_A = 25^\circ\text{C}$

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	TYP	MAX	UNIT
$t_{t(out)}$ Watchdog time-out			$V_{I(SENSEn)} \geq V_{IT} + 0.2\text{ V}$, See timing diagram	0.5	0.8	1.2	s
t_d Delay time			$V_{I(SENSEn)} \geq V_{IT} + 0.2\text{ V}$, See timing diagram	70	100	140	ms
t_{PHL} Propagation (delay) time, high- to low-level output	SENSEn	$\overline{\text{RESET}}$	$V_{IH} = V_{IT} + 0.2\text{ V}$, $V_{IL} = V_{IT} - 0.2\text{ V}$		1	5	μs
t_{PHL} Propagation (delay) time, high- to low-level output	PFI	$\overline{\text{PFO}}$			0.5	1	μs
t_{PLH} Propagation (delay) time, low- to high-level output							

TYPICAL CHARACTERISTICS

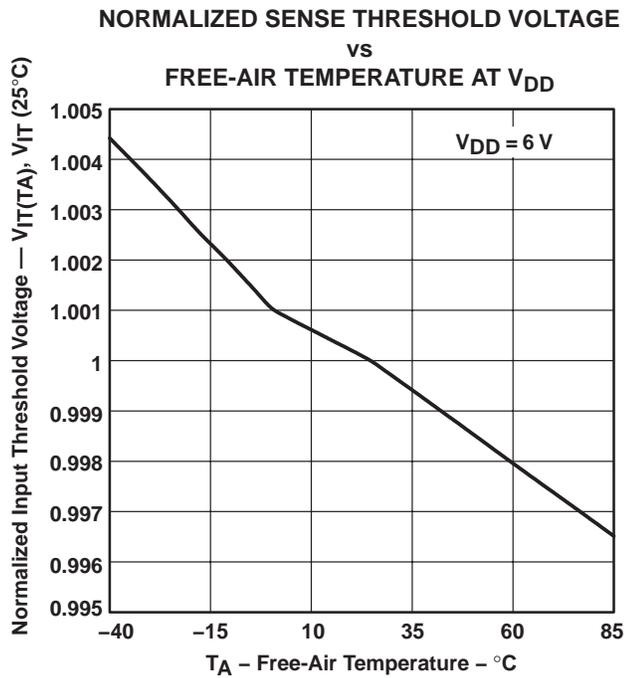


Figure 2

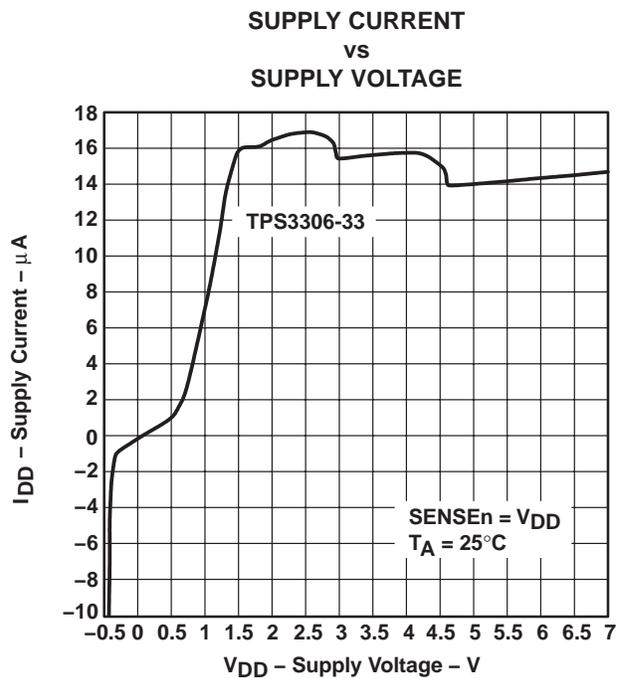


Figure 3

TYPICAL CHARACTERISTICS

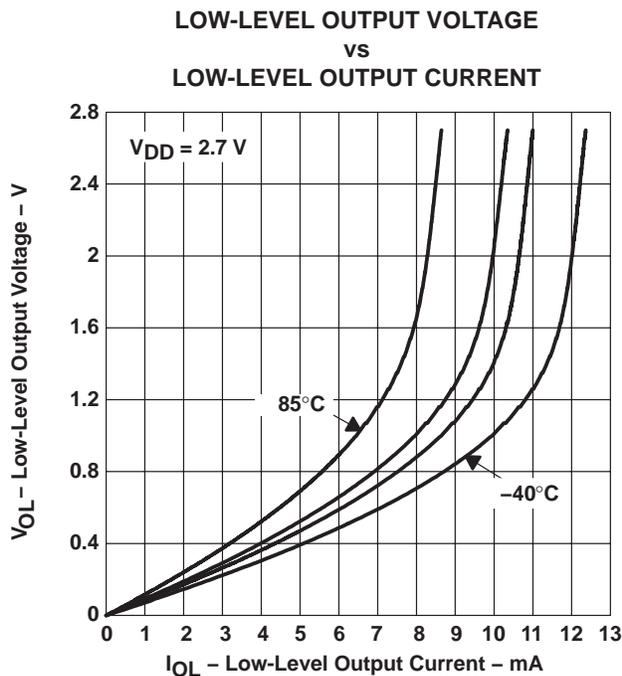


Figure 4

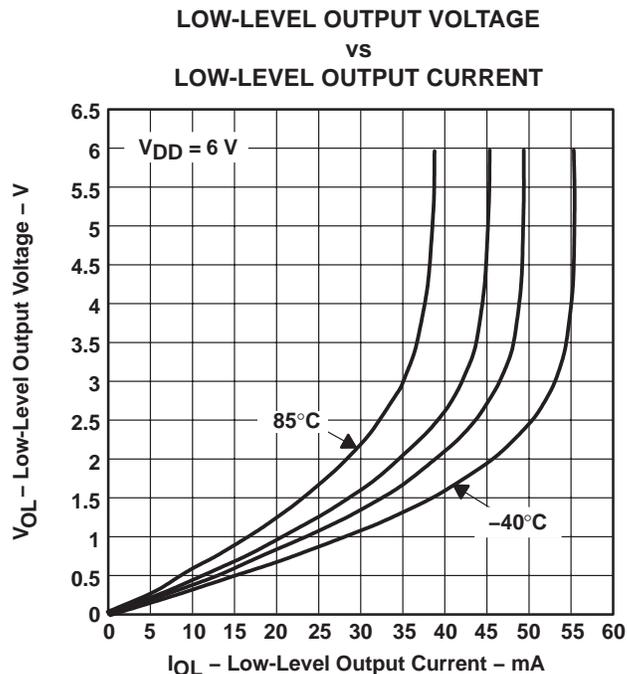


Figure 5

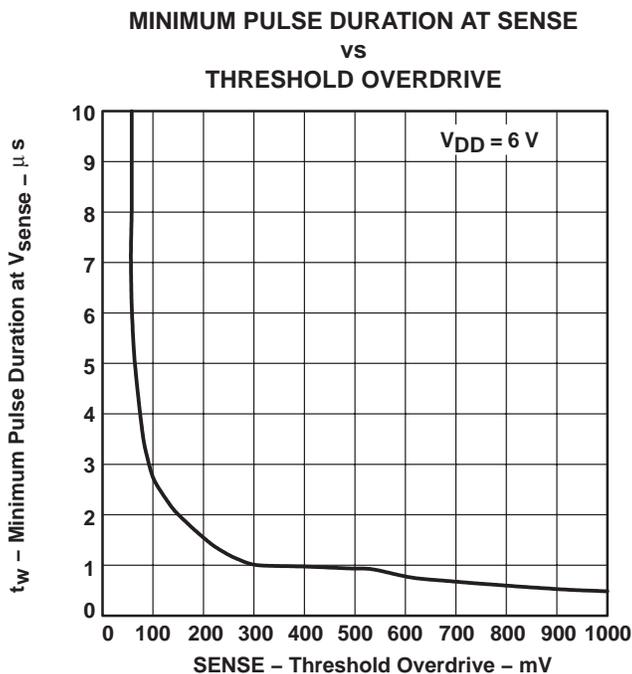


Figure 6

PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
TPS3306-15QDRG4Q1	Obsolete	Production	SOIC (D) 8	-	-	Call TI	Call TI	-40 to 125	615Q1
TPS3306-15QDRQ1	Active	Production	SOIC (D) 8	2500 LARGE T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	615Q1
TPS3306-15QDRQ1.A	Active	Production	SOIC (D) 8	2500 LARGE T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	615Q1
TPS3306-18QDRG4Q1	Obsolete	Production	SOIC (D) 8	-	-	Call TI	Call TI	-40 to 125	618Q1
TPS3306-18QDRQ1	Active	Production	SOIC (D) 8	2500 LARGE T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	618Q1
TPS3306-18QDRQ1.A	Active	Production	SOIC (D) 8	2500 LARGE T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	618Q1
TPS3306-25QDRG4Q1	Obsolete	Production	SOIC (D) 8	-	-	Call TI	Call TI	-40 to 125	625Q1
TPS3306-33QDRG4Q1	Obsolete	Production	SOIC (D) 8	-	-	Call TI	Call TI	-40 to 125	633Q1
TPS3306-33QDRQ1	Active	Production	SOIC (D) 8	2500 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	633Q1
TPS3306-33QDRQ1.A	Active	Production	SOIC (D) 8	2500 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	633Q1

(1) **Status:** For more details on status, see our [product life cycle](#).

(2) **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

(3) **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

(4) **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

(5) **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

(6) **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative

and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

OTHER QUALIFIED VERSIONS OF TPS3306-Q1 :

- Catalog : [TPS3306](#)

NOTE: Qualified Version Definitions:

- Catalog - TI's standard catalog product

TAPE AND REEL INFORMATION

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE

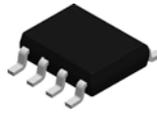

*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TPS3306-15QDRQ1	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
TPS3306-18QDRQ1	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
TPS3306-33QDRQ1	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1

TAPE AND REEL BOX DIMENSIONS


*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TPS3306-15QDRQ1	SOIC	D	8	2500	350.0	350.0	43.0
TPS3306-18QDRQ1	SOIC	D	8	2500	350.0	350.0	43.0
TPS3306-33QDRQ1	SOIC	D	8	2500	350.0	350.0	43.0

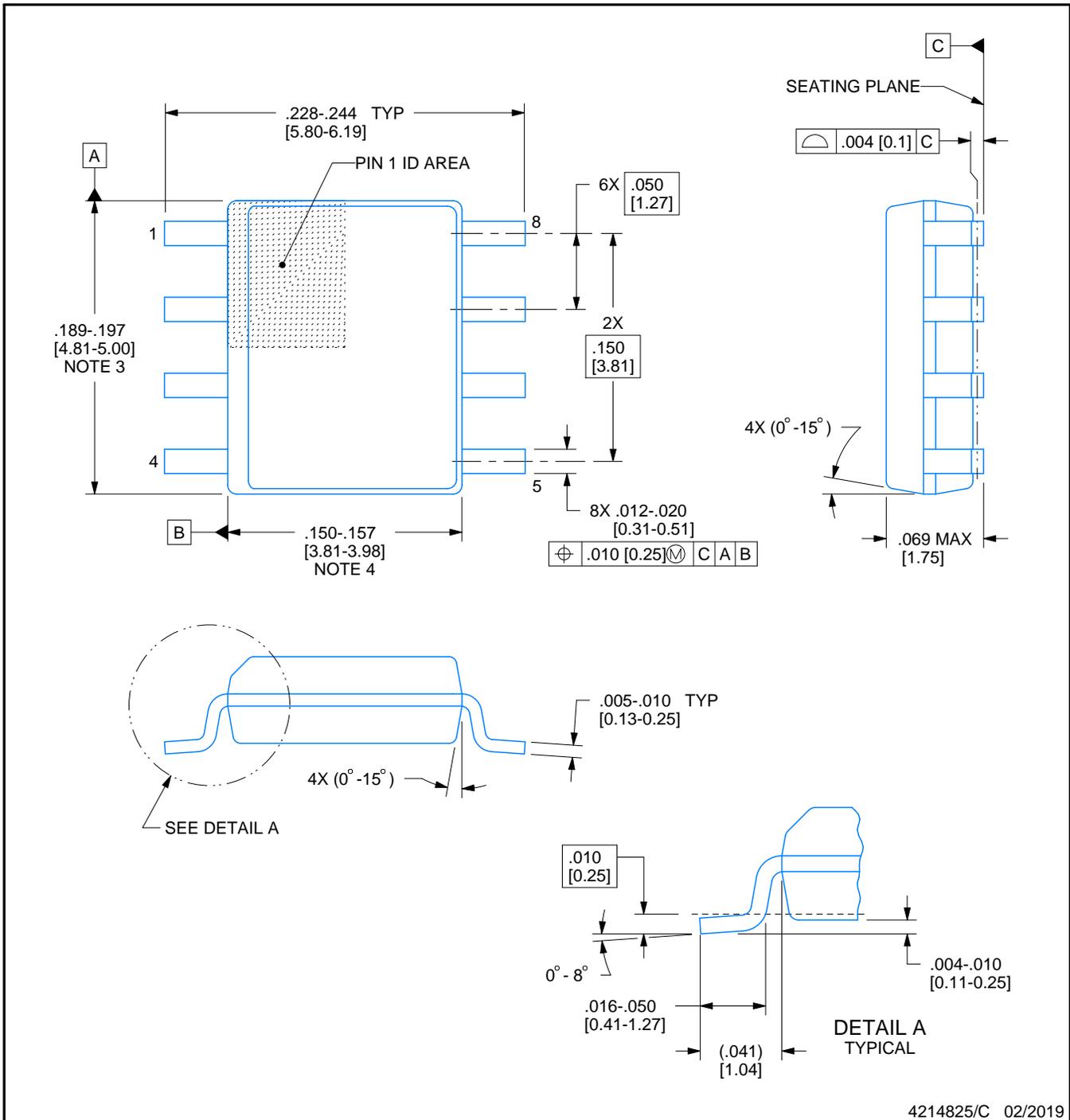


D0008A

PACKAGE OUTLINE

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



4214825/C 02/2019

NOTES:

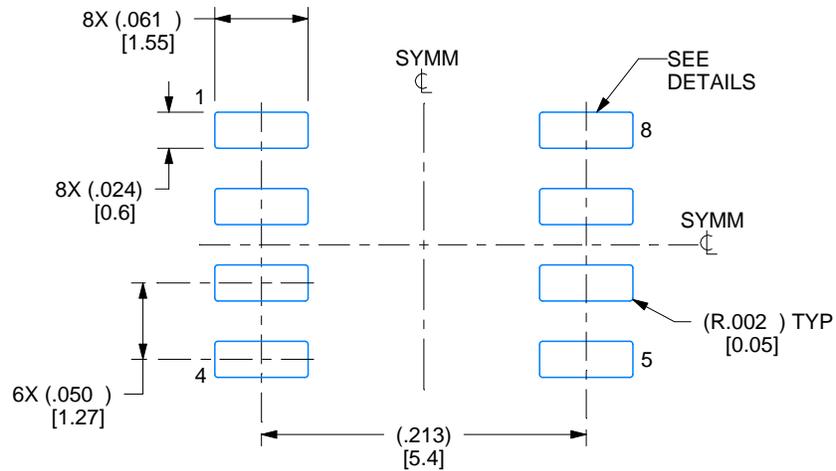
1. Linear dimensions are in inches [millimeters]. Dimensions in parenthesis are for reference only. Controlling dimensions are in inches. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed $.006$ [0.15] per side.
4. This dimension does not include interlead flash.
5. Reference JEDEC registration MS-012, variation AA.

EXAMPLE BOARD LAYOUT

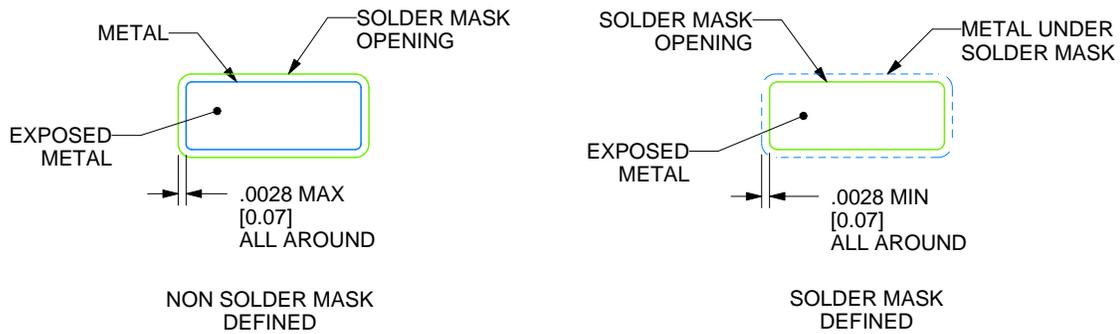
D0008A

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



LAND PATTERN EXAMPLE
EXPOSED METAL SHOWN
SCALE:8X



SOLDER MASK DETAILS

4214825/C 02/2019

NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

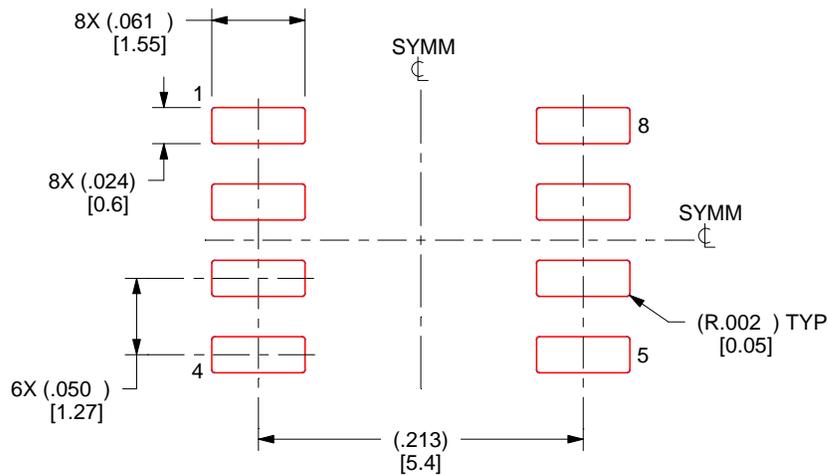
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

EXAMPLE STENCIL DESIGN

D0008A

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



SOLDER PASTE EXAMPLE
BASED ON .005 INCH [0.125 MM] THICK STENCIL
SCALE:8X

4214825/C 02/2019

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATASHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, regulatory or other requirements.

These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you fully indemnify TI and its representatives against any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI's products are provided subject to [TI's Terms of Sale](#), [TI's General Quality Guidelines](#), or other applicable terms available either on ti.com or provided in conjunction with such TI products. TI's provision of these resources does not expand or otherwise alter TI's applicable warranties or warranty disclaimers for TI products. Unless TI explicitly designates a product as custom or customer-specified, TI products are standard, catalog, general purpose devices.

TI objects to and rejects any additional or different terms you may propose.

Copyright © 2026, Texas Instruments Incorporated

Last updated 10/2025